

# NSR0340HT1G

## Schottky Barrier Diode

Schottky barrier diodes are optimized for very low forward voltage drop and low leakage current and are used in a wide range of dc-dc converter, clamping and protection applications in portable devices. NSR0340H in a SOD-323 miniature package enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.

### Features

- Very Low Forward Voltage Drop –415 mV @ 100 mA
- Low Reverse Current – 0.4  $\mu$ A @ 25 V  $V_R$
- 250 mA of Continuous Forward Current
- Power Dissipation of 160 mW with Minimum Trace
- Very High Switching Speed
- Low Capacitance –  $C_T$  = 6 pF
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### Typical Applications

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc-dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

### Markets

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs and PDAs
- GPS

### MAXIMUM RATINGS

| Rating                                        | Symbol    | Value              | Unit |
|-----------------------------------------------|-----------|--------------------|------|
| Reverse Voltage                               | $V_R$     | 40                 | Vdc  |
| Forward Continuous Current (DC)               | $I_F$     | 250                | mA   |
| Non-Repetitive Peak Forward Surge Current     | $I_{FSM}$ | 1.0                | A    |
| ESD Rating: Human Body Model<br>Machine Model | ESD       | Class 2<br>Class A |      |

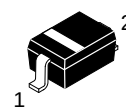
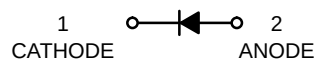
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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## 40 VOLT SCHOTTKY BARRIER DIODE



**SOD-323  
CASE 477  
STYLE 1**

### MARKING DIAGRAM



AD = Specific Device Code

M = Date Code

▪ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

| Device       | Package              | Shipping†          |
|--------------|----------------------|--------------------|
| NSR0340HT1G  | SOD-323<br>(Pb-Free) | 3000 / Tape & Reel |
| NSVR0340HT1G | SOD-323<br>(Pb-Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# THERMAL CHARACTERISTICS

| Characteristic                                                                                           | Symbol                   | Max         | Unit                     |
|----------------------------------------------------------------------------------------------------------|--------------------------|-------------|--------------------------|
| Thermal Resistance<br>Junction-to-Ambient (Note 1)<br>Total Power Dissipation @ $T_A = 25^\circ\text{C}$ | $R_{\theta JA}$<br>$P_D$ | 740<br>160  | $^\circ\text{C/W}$<br>mW |
| Thermal Resistance<br>Junction-to-Ambient (Note 2)<br>Total Power Dissipation @ $T_A = 25^\circ\text{C}$ | $R_{\theta JA}$<br>$P_D$ | 460<br>270  | $^\circ\text{C/W}$<br>mW |
| Junction and Storage Temperature Range                                                                   | $T_J, T_{stg}$           | -55 to +150 | $^\circ\text{C}$         |

1. Mounted onto a 4 in square FR-4 board 10 mm sq. 1 oz. Cu 0.06" thick single-sided. Operating to steady state.
2. Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single-sided. Operating to steady state.

# ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic                                                                                        | Symbol   | Min | Typ               | Max               | Unit          |
|-------------------------------------------------------------------------------------------------------|----------|-----|-------------------|-------------------|---------------|
| Reverse Leakage<br>( $V_R = 10\text{ V}$ )<br>( $V_R = 25\text{ V}$ )<br>( $V_R = 40\text{ V}$ )      | $I_R$    |     | 0.2<br>0.4<br>1.3 | 1.0<br>3.0<br>6.0 | $\mu\text{A}$ |
| Forward Voltage<br>( $I_F = 10\text{ mA}$ )<br>( $I_F = 100\text{ mA}$ )<br>( $I_F = 200\text{ mA}$ ) | $V_F$    |     | 320<br>415<br>470 | 350<br>490<br>590 | mV            |
| Total Capacitance<br>( $V_R = 10\text{ V}$ , $f = 1\text{ MHz}$ )                                     | $C_T$    |     | 6.0               |                   | pF            |
| Reverse Recovery Time<br>( $I_F = I_R = 10\text{ mA}$ , $I_R = 1.0\text{ mA}$ )                       | $t_{rr}$ |     | 5.0               |                   | ns            |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

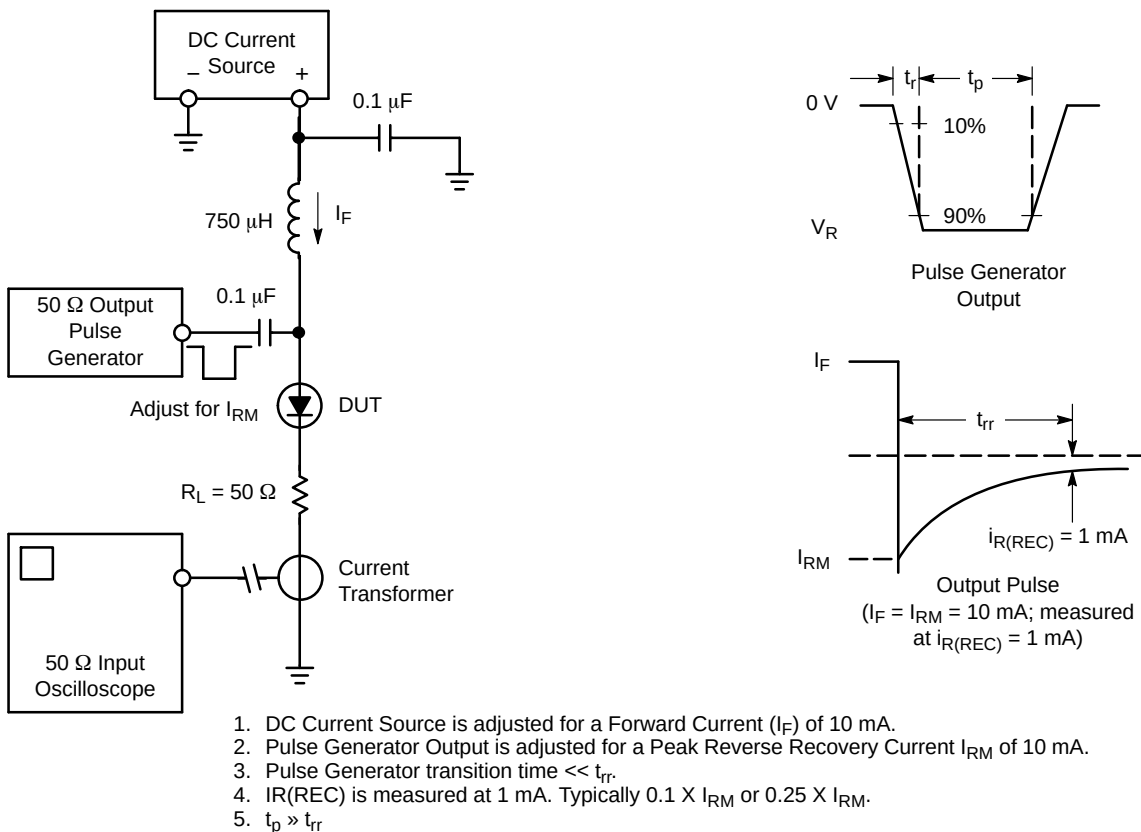


Figure 1. Recovery Time Equivalent Test Circuit

TYPICAL CHARACTERISTICS

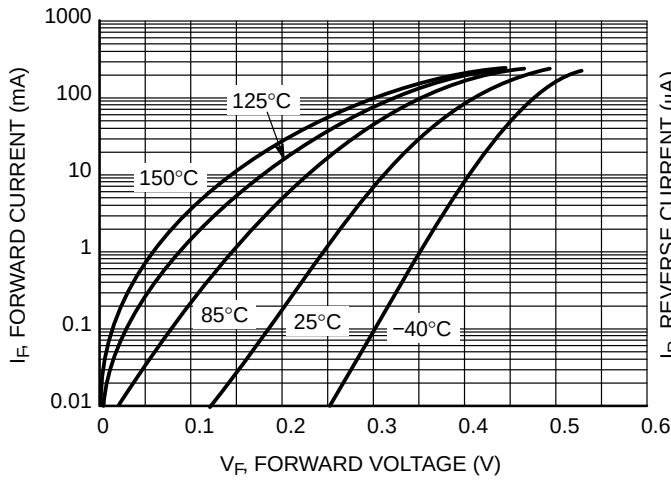


Figure 2. Forward Voltage

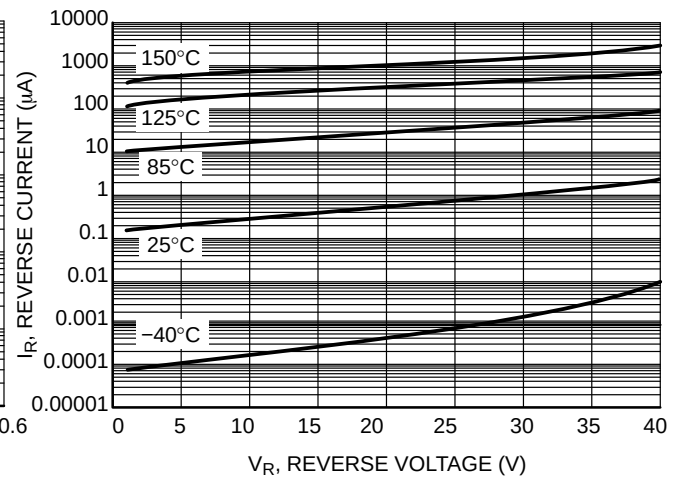


Figure 3. Leakage Current

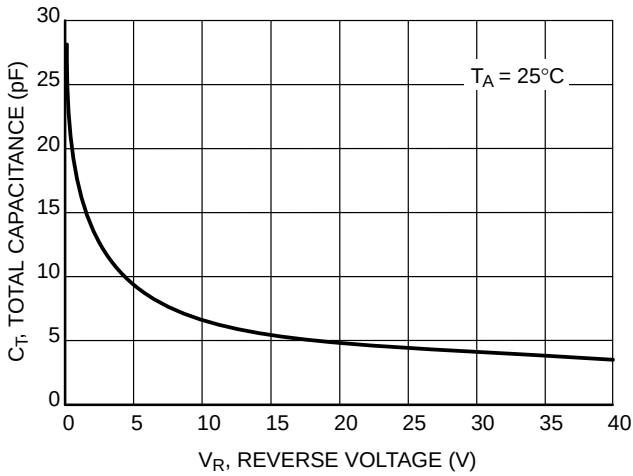


Figure 4. Total Capacitance

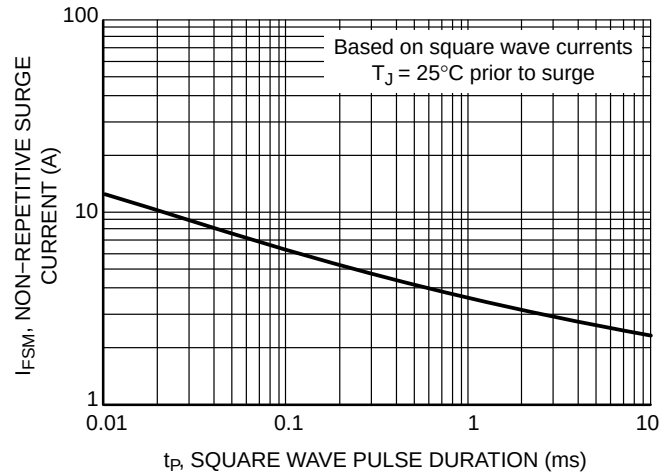
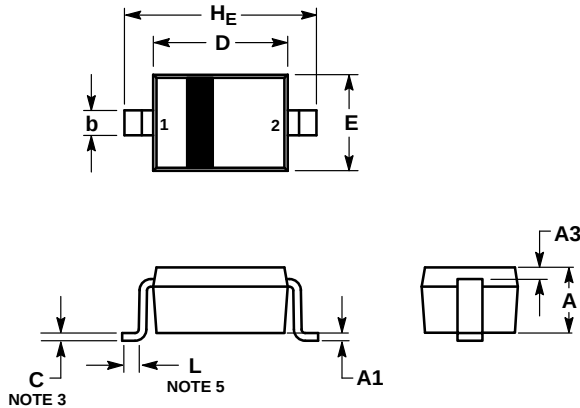


Figure 5. Non-Repetitive Surge Current

# NSR0340HT1G

## PACKAGE DIMENSIONS

**SOD-323**  
CASE 477-02  
ISSUE H



### NOTES:

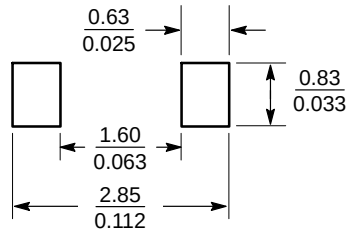
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
5. DIMENSION L IS MEASURED FROM END OF RADIUS.

| DIM | MILLIMETERS |      |       | INCHES    |       |       |
|-----|-------------|------|-------|-----------|-------|-------|
|     | MIN         | NOM  | MAX   | MIN       | NOM   | MAX   |
| A   | 0.80        | 0.90 | 1.00  | 0.031     | 0.035 | 0.040 |
| A1  | 0.00        | 0.05 | 0.10  | 0.000     | 0.002 | 0.004 |
| A3  | 0.15 REF    |      |       | 0.006 REF |       |       |
| b   | 0.25        | 0.32 | 0.4   | 0.010     | 0.012 | 0.016 |
| C   | 0.089       | 0.12 | 0.177 | 0.003     | 0.005 | 0.007 |
| D   | 1.60        | 1.70 | 1.80  | 0.062     | 0.066 | 0.070 |
| E   | 1.15        | 1.25 | 1.35  | 0.045     | 0.049 | 0.053 |
| L   | 0.08        |      |       | 0.003     |       |       |
| HE  | 2.30        | 2.50 | 2.70  | 0.090     | 0.098 | 0.105 |

### STYLE 1:

1. CATHODE
2. ANODE

## SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**NSR0340H/D**